5	>			1 1010 00 - 17	1	
	DF 1102-*D3-2V (22)		TAKINO	SPECIFICATION SHEET	SPECIFI	<u> </u>
	_		DART N			ן ו
	4124-	DRAWING NO.	DRA	AT:Assurance Test X:Applicable Test	.	Note QT:Qualification Test
09. 05. 27	YK. NAKATSU 09.	DRAWN				
09. 06. 03		CHECKED				
09. 06. 03	TA	APPROVED				
14. 02. 26		RA	MI. SAKIMURA	D1S-H-008540	DIS	1
DATE	CHECKED D	Ö	DESIGNED	DESCRIPTION OF REVISIONS	DESCRIPTION	COUNT
	CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 500MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS.  X		<u></u>	EXPOSED AT 40 ± 2°C, 90 TO 95%, 96 h.	EXPOSE	(STEADY STATE)
	30mΩ E: 1000MΩ R LOOSENI		35 °C 15 min	15 IICS -55→5 TO 35→+85 →5 30→5 TO 15 →30 →5 SS.	<u>.                                    </u>	ENVIKONMEN I AL RAPID CHANGE OF TEMPERATURE
	×					
1	NO ELECTRICAL DISCONTINUITY OF 1µS.  NO DAMAGE, CRACK OR LOOSENESS  OF DARTS  OF DARTS		PLITUDE (1)	REQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE .75 mm, AT 2 h, FOR 3 DIRECTIONS.	0.75 mm,	VIBRATION
	SISTANCE: 30mΩ MAX. CRACK OR LOOSENESS X	CONTACT RESISTANCE: NO DAMAGE, CRACK OR OF PARTS.	IONS.	30 TIMES INSERTIONS AND EXTRACTIONS	30 TIMES INSERTION	MECHANICAL MECHANICAL OPERATION
	BREARDOWN.	NO FLAGHOVER OR BREAKDOWN.	N.C.	650V AC FOR 1 min.	650V A	VOLIAGE PROOF
	×	1000MΩ MIN.	10	) C.	500V DC	RESISTANCE
	×	30mΩ MAX.	30	100mA (DC OR 1000 Hz).	<del>ا</del> رار خ	CONTACT RESISTANCE   100mA (DC OR
$\vdash$	 			CONFIRMED VISUALLY.	CONFIRM	MARRING
×	AWING.	ACCORDING TO DRAWING.		VISUALLY AND BY MEASURING INSTRUMENT.		GENERAL EXAMINATION
1 1						CONSTRUCTION
<u></u> ≱1	REQUIREMENTS QT			됩		ITEM
		<b>O</b>	ICATIONS	SPECIFIC		
<i>&gt;</i> > >	AWG 22 : 2A AWG 24 TO 28 : 1A AWG 30 : 0.5A	G CURRENT		AWG 22 TO 26 : 2A AWG 28 : 1A AWG 30 : 0.5A	T	CURRENT
	30V AC	VOLTAGE	UL · CSA	250V AC	3E	VOLTAGE
2)	40% T0 + 70% (NOTE 2	HUMIDITY RANGE	HUMIDITY	40% T0 + 80%	HUMIDITY RANGE	HUMIDITY R.
2)	-10°C TO + 60°C (NOTE	TEMPERATURE RANGE	1) / TEMPER	-40°C TO + 85°C (NOTE	TEMPERATURE RANGE	RATING TEMPERATURE
		1	• 07074		5	

	SPECIFICATIONS	NOIT			
ITEM RESISTANCE TO	TEST METHOD  (A) ALITOMATIC SOLDERING (REELOW)	NO DEEC	REQUIREMENTS	QT	AT
SOLDERING HEAT	WREFLOW AREAN MAX 250°C WITHIN 10 MIN 230°C WITHIN 60 WPREHEATING AREAN 150 TO 180°C 90 TO 120 PUT THROUGH IN REFRO FEAVE IN AMBIENT TEMF HUMIDITY FOR 1 HOUR. 0 TEMPERATURE TO BE AN SECOND REFLOW.  MANUAL SOLDERING SOLDERING IRON TEMPER SOLDERING TIME :3s.		EXCESSIVE LOOSENESS OF THE TERMINALS.	×	1
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE,		A NEW UNIFORM COATING OF SOLDER	×	I
		VIXTAC AC	OURTACE BEING IMMERGED.		
REMARKS  NOTE 1:INCLUDING THE TEMP  NOTE 2:APPLY TO THE CONDITE 2:APPLY TO THE CONDITE	REMARKS  NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.  NOTE 2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD , AFTER PCB BOARD , OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERM STORAGE DURING TRANSPORTATION.  NOTE 3:THE TEMPERATURE PROFILE SHALL BE APPLIED WITHIN 168 HOURS AFTER OPENING MOISTURE-PROOF PACKAGING. WHEN 168 HOURS PASSED AFTER OPENING , APPLY THE BOTTOM REQUIREMENTS.  (REFLOW AREA)  MAX 240°C WITHIN 10 sec.  MIN 230°C WITHIN 60 sec.  (PREHEATING AREA)  150 TO 180°C 90 TO 120 s.	JNUSED PRODU IDITY RANGE IS HOURS AFTER I	ICTS BEFORE PCB ON BOARD APPLIED FOR INTERM OPENING MOISTURE-PROOF OM REQUIREMENTS.		
Unless otherwise speci	Unless otherwise specifid , refer to IEC 60512.  Note QT-Qualification Test AT-Assurance Test X-Applicable Test	DRAWING NO	NO EL C4-314124-01	의	
	SPECIFICATION SHEET	PART NO	DF11C	2	
G	TRIC	CODE NO	.   '	2	2/2